

**HBS410** 

#### 4.0A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

### Product Summary (@TA = +25°C)

| VRRM (V) | lo (A) | V <sub>F</sub> (V) | I <sub>R</sub> (μA) |
|----------|--------|--------------------|---------------------|
| 1000     | 4.0    | 0.98               | 5                   |

### **Description and Applications**

General purpose use in AC-to-DC bridge full wave rectification for Fast Charging, Switching Power Supply, USB PD, Adapter and 3-in-1 DTV Power Board, etc.

## **Features and Benefits**

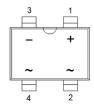
- Glass Passivated Die Construction
- Miniature Surface Mount Package Saves Space on PC Boards
- High Current Capability
- High Forward Current Capability up to 4.0A
- High Heat Dissipation Capability
- Low Profile Package
- Low Forward Voltage Drop
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

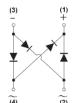
- Case: HBS
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: As Marked on Body
- Weight: 0.384grams (Approximate)



Top View



Pin Diagram



Internal Schematic

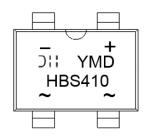
### Ordering Information (Note 4)

| Part Number | Compliance | Case | Packaging         |
|-------------|------------|------|-------------------|
| HBS410-13   | Commercial | HBS  | 2,500/Tape & Reel |

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



HBS410 = Product Type Marking Code Jii = Manufacturers' Code Marking YMD = Date Code Marking

Y = Last Digit of Year (ex: 0 = 2020)M = See Month/Code Table Below

D = Day 1 to 9 = 1 to 9; Day 10 to 31 = A to V

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code  | 1   | 2   | 3   | 4   | 5   | 6   | 7   | 8   | 9   | 0   | N   | D   |

**HBS410** Document number: DS42360 Rev.3 - 2



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Characteristic   | Symbol              | Value | Unit             |
|--|---------------------|-------|------------------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage               | VRRM<br>VRWM<br>VR  | 1,000 | V                |
| RMS Reverse Voltage  | V <sub>R(RMS)</sub> | 700   | V                |
| Average Rectified Output Current (Note 5) @ T <sub>A</sub> = +25°C                                   | lo                  | 4.0   | Α                |
| Non-Repetitive Peak Forward Surge Current, 8.3ms<br>Single Half Sine-Wave Superimposed on Rated Load | IFSM                | 120   | Α                |
| Non-Repetitive Peak Forward Surge Current, 1.0ms<br>Single Half Sine-Wave Superimposed on Rated Load | I <sub>FSM</sub>    | 240   | Α                |
| $I^{2}t$ Rating for Fusing (1ms < t < 8.3ms)   | l <sup>2</sup> t    | 60    | A <sup>2</sup> S |

# **Thermal Characteristics**

| Characteristic   | Symbol                            | Value       | Unit |
|--|-----------------------------------|-------------|------|
| Typical Thermal Resistance, Junction to Ambient (Note 5) (Per Element) | R <sub>θJA</sub>                  | 75          | °C/W |
| Typical Thermal Resistance, Junction to Lead (Per Element)             | Rejl                              | 21          | °C/W |
| Typical Thermal Resistance, Junction to Case (Per Element)             | Rejc                              | 13          | °C/W |
| Operating and Storage Temperature Range                                | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

### Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic                         | Symbol      | Min   | Тур                  | Max                  | Unit | Test Condition  |
|--|-------------|-------|----------------------|----------------------|------|---|
| Reverse Breakdown Voltage (Note 6)     | $V_{(BR)R}$ | 1,000 | _                    | _                    | V    | $I_R = 10\mu A$   |
| Forward Voltage (Per Element)          | VF          |       | 0.84<br>0.88<br>0.93 | 0.89<br>0.93<br>0.98 | V    | IF = 1A, T <sub>A</sub> = +25°C<br>IF = 2A, T <sub>A</sub> = +25°C<br>I <sub>F</sub> = 4A, T <sub>A</sub> = +25°C |
| Leakage Current (Note 6) (Per Element) | IR          |       | 0.15<br>20           | 5<br>100             | μΑ   | V <sub>R</sub> = 1,000V, T <sub>A</sub> = +25°C<br>V <sub>R</sub> = 1,000V, T <sub>A</sub> = +125°C               |
| Total Capacitance (Per Element)        | Ст          | _     | 40                   | _                    | pF   | $V_R = 4V$ , $f = 1.0MHz$   |

6. Short duration pulse test used to minimize self-heating effect.

5. Device mounted on 15mmx12mmx1.6mm AL Pad attached on 100mmx75mmx27mm Fin heatsink. Thermal resistance test performed in accordance with JESD-51.

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Notes:

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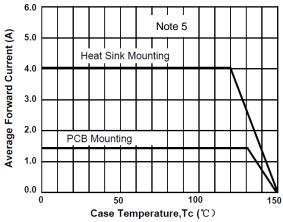


Figure 1. Forward Current Derating

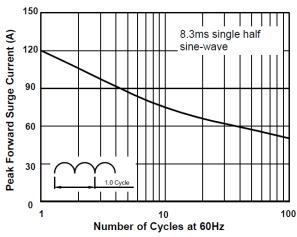


Figure 3. Maximum Non-Repetitive Forward Surge Current

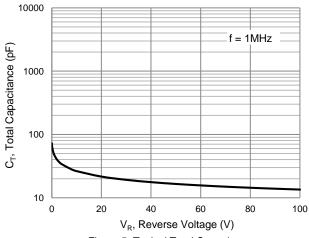


Figure 5. Typical Total Capacitance

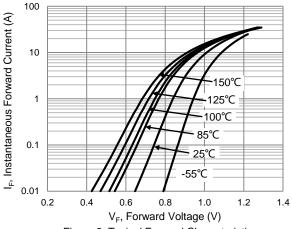


Figure 2. Typical Forward Characteristics

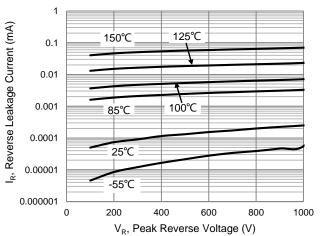


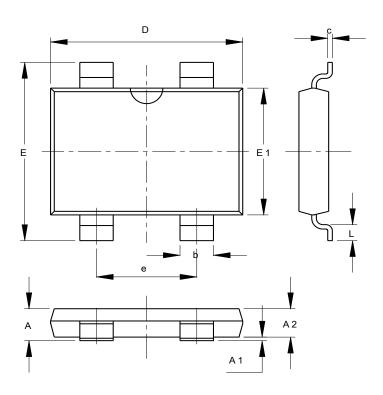
Figure 4. Typical Reverse Characteristics



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **HBS**

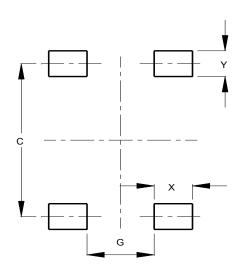


| HBS                  |       |       |     |  |  |  |  |
|----------------------|-------|-------|-----|--|--|--|--|
| Dim                  | Min   | Max   | Тур |  |  |  |  |
| Α                    | 1.45  | 1.80  |     |  |  |  |  |
| A1                   | 0.00  | 0.20  |     |  |  |  |  |
| A2                   | 1.45  | 1.65  |     |  |  |  |  |
| b                    | 1.70  | 1.90  |     |  |  |  |  |
| С                    | 0.15  | 0.35  |     |  |  |  |  |
| D                    | 10.05 | 10.35 |     |  |  |  |  |
| Е                    | 9.75  | 10.05 |     |  |  |  |  |
| E1                   | 6.85  | 7.15  |     |  |  |  |  |
| е                    | 5.25  | 5.60  |     |  |  |  |  |
| ٦                    | 0.45  | 0.95  |     |  |  |  |  |
| All Dimensions in mm |       |       |     |  |  |  |  |

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.





| Dimensions | Value<br>(in mm) |  |  |  |
|------------|------------------|--|--|--|
| С          | 8.92             |  |  |  |
| G          | 3.50             |  |  |  |
| Х          | 2.00             |  |  |  |
| Υ          | 1.50             |  |  |  |



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